IRFZ40

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

 $R_{DS(on)}(\Omega)$

Q_{gs} (nC)

Q_{gd} (nC)

Q_a (Max.) (nC)

Configuration

Power MOSFET

FEATURES

- Dynamic dV/dt rating
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

S

N-Channel MOSFET

0.028

60

67

18

25

Single

 $V_{GS} = 10 V$

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ40PbF
Lead (Pb)-free and halogen-free	IRFZ40PbF-BE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)									
PARAMETER		SYMBOL	LIMIT	UNIT					
Drain-source voltage			V _{DS}	60	v				
Gate-source voltage			V _{GS}	± 20	v				
Continuous drain current	V _{GS} at 10 V	$T_{C} = 25 \degree C$ T _C = 100 °C	- I _D	50					
	V _{GS} at 10 V	T _C = 100 °C		36	А				
Pulsed drain current ^a			I _{DM}	200					
Linear derating factor				1.0	W/°C				
Single pulse avalanche energy ^b			E _{AS}	100	mJ				
Maximum power dissipation	T _C =	25 °C	PD	150	W				
Peak diode recovery dV/dt ^c			dV/dt	4.5	V/ns				
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C					
Soldering recommendations (peak temperature) ^d	For 10 s			300					
Mounting torque	6-32 or M3 screw			10	lbf ∙ in				
				1.1	N·m				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 44 µH, R_q = 25 Ω , I_{AS} = 51 A (see fig. 12)

c. $I_{SD} \le 51$ A, dI/dt ≤ 250 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

e. Current limited by the package, (die current = 51 A)

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP	TYP. MAX.			UNIT			
Maximum junction-to-ambient	R _{thJA}	- 62 0.50 -							
Case-to-sink, flat, greased surface	R _{thCS}					°C/W			
Maximum junction-to-case (drain)	R _{thJC}	- 1.0							
SPECIFICATIONS (T _J = 25 °C, u	unless otherw	ise noted)							
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static	L					•			
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 μA	60	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.060	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}		· V _{GS} , I _D = 2		2.0	-	4.0	V	
Gate-source leakage	I _{GSS}		$V_{\rm GS} = \pm 20$		-	-	± 100	nA	
Zero gate voltage drain current	000	V _{DS} =	V _{DS} = 60 V, V _{GS} = 0 V			-	25		
	I _{DSS}	V _{DS} = 48 V,	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			-	250	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D	= 31 A ^b	-	-	0.028	Ω	
Forward transconductance	9 _{fs}	V _{DS} :	= 25 V, I _D =	31 A	15	-	-	S	
Dynamic									
Input capacitance	C _{iss}		V _{GS} = 0 V,		-	1900	-		
Output capacitance	C _{oss}		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	920	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1.			-	170	-		
Total gate charge	Qg			I _D = 51 A, V _{DS} = 48 V, see fig. 6 and 13 ^b	-	-	67	nC	
Gate-source charge	Q _{gs}	V _{GS} = 10 V			-	-	18		
Gate-drain charge	Q _{gd}				-	-	25		
Turn-on delay time	t _{d(on)}				-	14	-		
Rise time	t _r	V_{DD} = 30 V, I _D = 51 A, R _g = 9.1 Ω, R _D = 0.55 Ω, see fig. 10 ^b		-	110	-	ns		
Turn-off delay time	t _{d(off)}			-	45	-			
Fall time	t _f				-	92	-	-	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact			-	4.5	-	nH	
Internal source inductance	L _S				-	7.5	-		
Drain-Source Body Diode Characteristi	cs	•				•	•		
Continuous source-drain diode current	١ _S	MOSFET symbol showing the		-	-	50	A		
Pulsed diode forward current ^a	I _{SM}	p - n junction diode			-	-		200	
Body diode voltage	V _{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 51 \ A, \ V_{GS} = 0 \ V^b$			-	-	2.5	V	
Body diode reverse recovery time	t _{rr}	T _J = 25 °C, I _F = 51 A, dl/dt = 100 A/μs		-	120	180	ns		
Body diode reverse recovery charge	Q _{rr}			-	0.53	0.80	nC		
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn			on is dor	ominated by L _S and L _D)			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

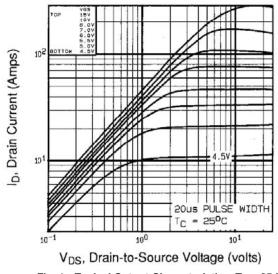
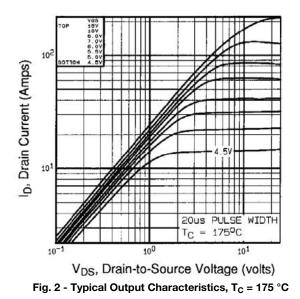


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$



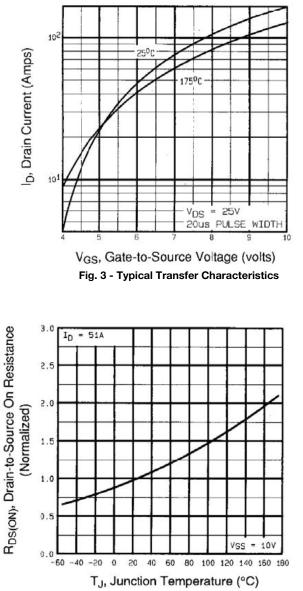
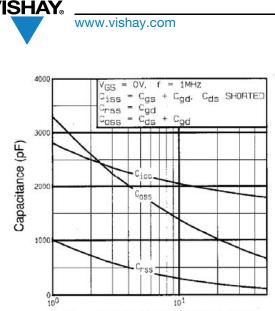


Fig. 4 - Normalized On-Resistance vs. Temperature

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V_{DS}, Drain-to-Source Voltage (volts)

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

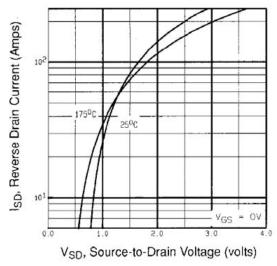


Fig. 7 - Typical Source-Drain Diode Forward Voltage

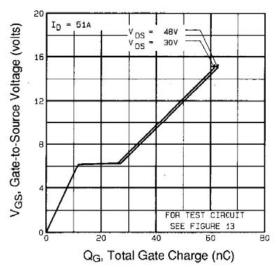
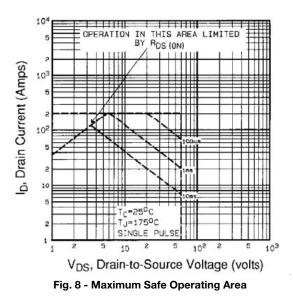


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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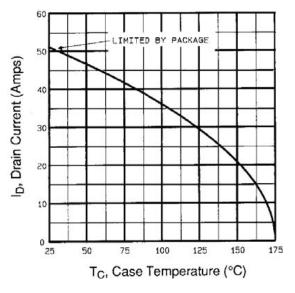


Fig. 9 - Maximum Drain Current vs. Case Temperature

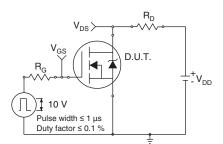


Fig. 10a - Switching Time Test Circuit

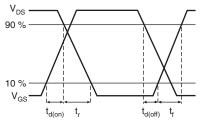
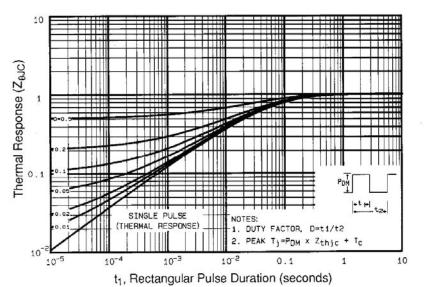


Fig. 10b - Switching Time Waveforms





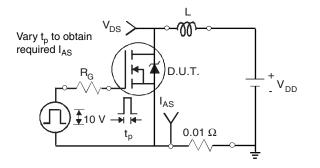
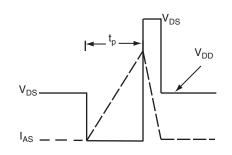
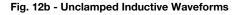


Fig. 12a - Unclamped Inductive Test Circuit





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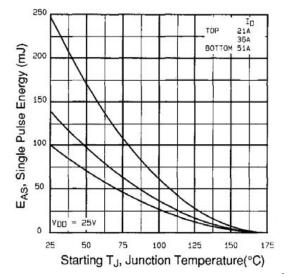


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

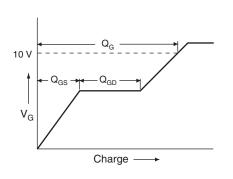


Fig. 13a - Basic Gate Charge Waveform

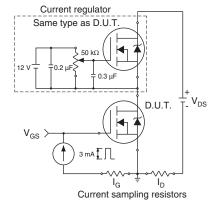
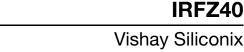


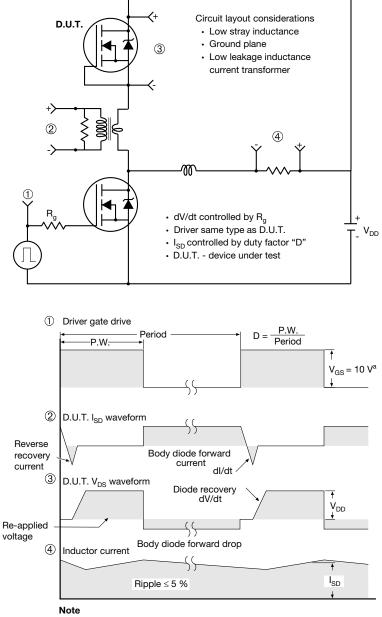
Fig. 13b - Gate Charge Test

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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